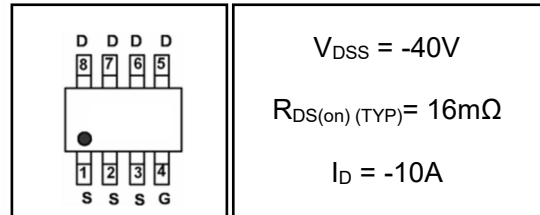


-10A -40V P-channel Enhancement Mode Power MOSFET

1 Description

The P-channel enhancement mode power mosfets used advanced trench technology design, provided excellent $R_{DS(on)}$ and low gate charge. Which accords with the RoHS standard.

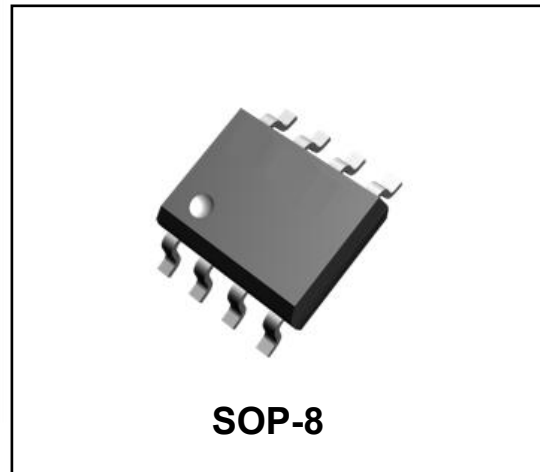


2 Features

- Low on resistance
- Low gate charge
- Fast switching
- Low reverse transfer capacitances
- 100% single pulse avalanche energy test
- 100% ΔV_{DS} test

3 Applications

- Power switching applications
- DC-DC converters
- Full bridge control



4 Electrical Characteristics

4.1 Absolute Maximum Ratings (Tc=25°C, unless otherwise noted)

Parameter		Symbol	Rating	Units
Drian-to-Source Voltage		V_{DSS}	-40	V
Gate-to-Source Voltage		V_{GSS}	± 20	V
Continuous Drain Current	$T_C=25^\circ C$	I_D	-10	A
	$T_C=100^\circ C$		-8	A
Pulsed Drain Current ⁽¹⁾		I_{DM}	-40	A
Single Pulse Avalanche Energy ⁽⁴⁾		E_{AS}	240	mJ
Power Dissipation	$T_a=25^\circ C$	P_{tot}	1.6	W
	$T_C=25^\circ C$	P_{tot}	6.7	W
Junction Temperature Range		T_j	-55~150	$^\circ C$
Storage Temperature Range		T_{stg}	-55~150	$^\circ C$

4.2 Thermal Characteristics

Parameter	Symbol	Value			Units
		Min	Typ	Max	
Thermal Resistance, Junction to Lead	R_{thJL}	--	18.6	--	$^\circ C/W$
Thermal Resistance, Junction to Ambient	R_{thJA}	--	78.6	--	$^\circ C/W$

4.3 Electrical Characteristics (Tc=25°C, unless otherwise noted)

Parameter	Symbol	Test Condition	Value			Units
			Min	Typ	Max	
Off Characteristics						
Drain-to-Source Breakdown Voltage	BV _{DSS}	I _D =-250μA, V _{GS} =0V	-40	--	--	V
Drain-to-Source Leakage Current	I _{DSS}	V _{DS} =-40V, V _{GS} =0V, T _C =25°C	--	--	-1	μA
		V _{DS} =-40V, V _{GS} =0V, T _C =125°C	--	--	-100	μA
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
On Characteristics						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-1.1	-1.8	-2.5	V
Drain-to-Source on-state Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-10A	--	16	20	mΩ
		V _{GS} =-4.5V, I _D =-10A	--	25	30	
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =-20V, f=1.0MHz	--	2800	--	pF
Output Capacitance	C _{oss}		--	230	--	
Reverse Transfer Capacitance	C _{rss}		--	180	--	
Gate Resisitance	R _g	V _{DD} =0V, V _{GS} =0V, F=1MHz	--	3.4	--	Ω
Switching Characteristics						
Turn-on Delay Time	t _{d(on)}	V _{GS} =-10V, I _D =-10A, V _{DS} =-20V, R _D =3Ω	--	14	--	nS
Turn-on Rise Time	t _r		--	53	--	
Turn-off Delay Time	t _{d(off)}		--	45	--	
Turn-off Fall Time	t _f		--	59	--	
Total Gate Charge	Q _g	I _D =-10A, V _{DD} =-20V, V _{GS} =-10V	--	46	--	nC
Gate-to-Source Charge	Q _{gs}		--	12.2	--	
Gate-to-Drain("Miller") Charge	Q _{gd}		--	6	--	
Drain-Source Diode Characteristics						
Reverse Recovery Time	T _{rr}	I _F =-10A, dI _F /dt=100A/μS	--	23	--	nS
Reverse Recovery Charge	Q _{rr}		--	11	--	nC
Diode Forward Voltage ⁽³⁾	V _{SD}	V _{GS} =0V, I _S =-10A	--	--	-1.2	V
Diode Forward Current	I _S		--	-10	--	A

Notes:

- 1: Repetitive rating, pulse width limited by maximum junction temperature.
- 2: Surface mounted on FR4 Board, t≤10sec.
- 3: Pulse width ≤ 300μs, duty cycle ≤ 2%.
- 4: L=0.5mH, I_{AS}=-31A, V_{DD}=-20V, V_G=-10V, Start T_J=25°C.

5 Typical characteristics diagrams

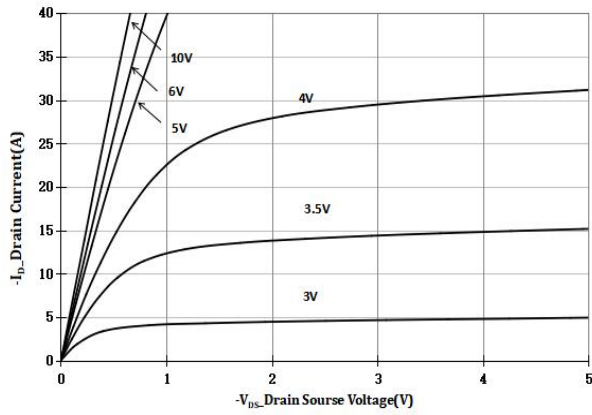


Fig 1 Output Characteristics

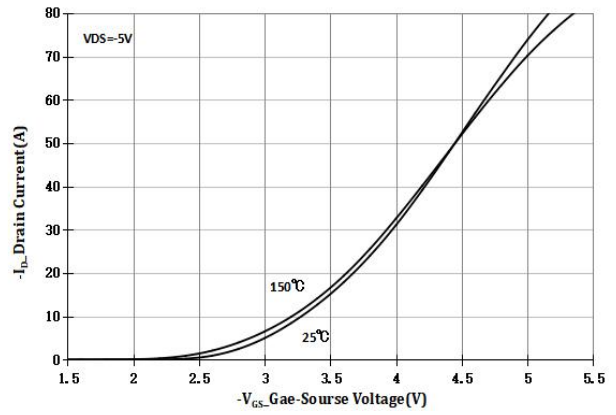


Fig 2 Transfer Characteristic

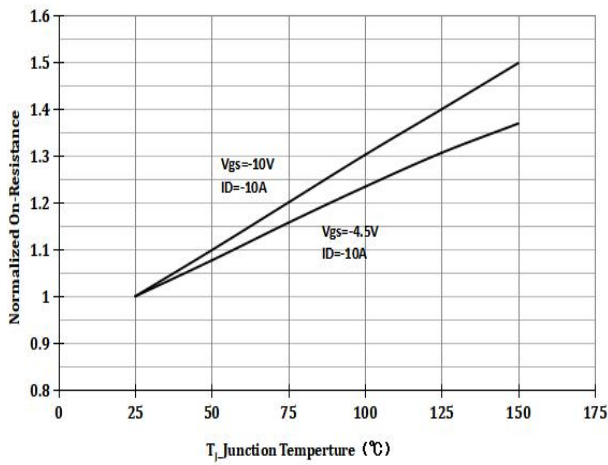


Fig 3 RDSON vs Junction Temperature

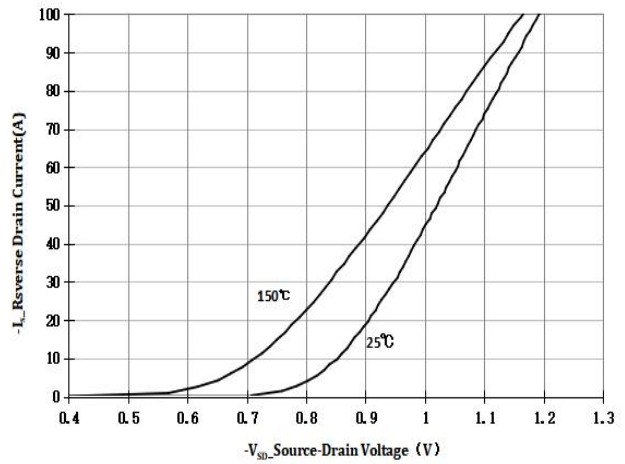


Fig 4 VSD_ Source-Drain Diode forward

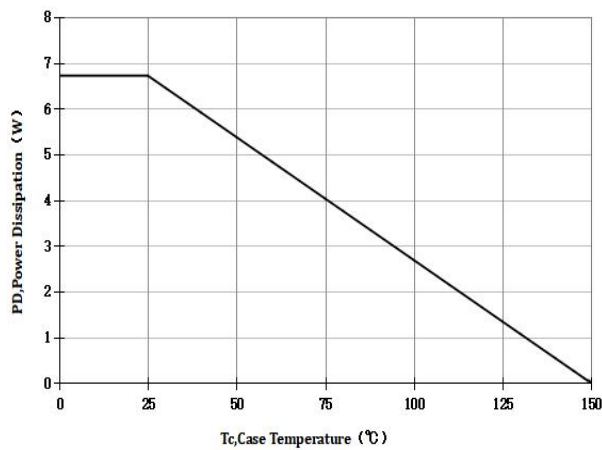


Fig 5 Power De-rating

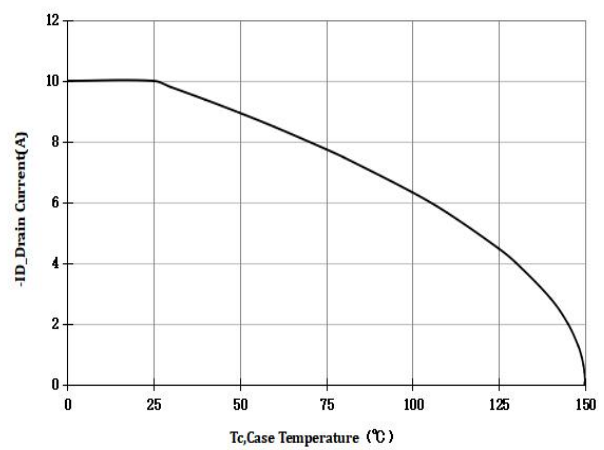


Fig 6 ID Current De-rating

5 Typical characteristics diagrams(continues)

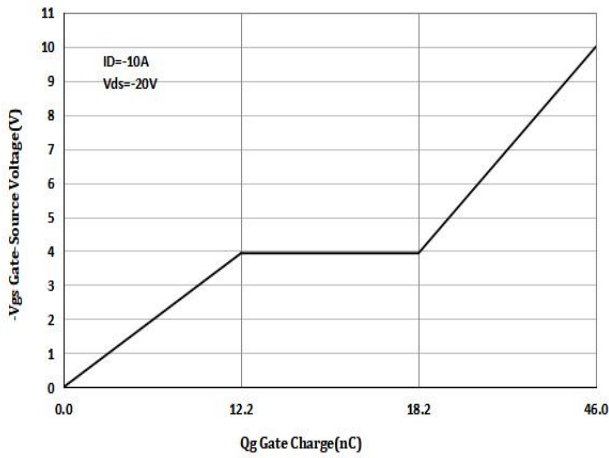


Fig 7 Gate Charge Figure

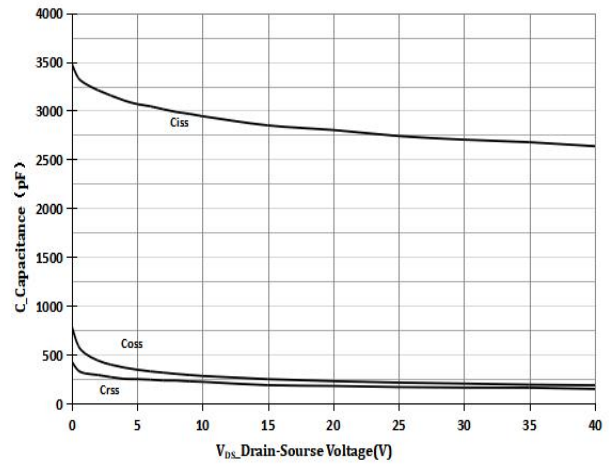


Fig 8 Capacitance vs Vds

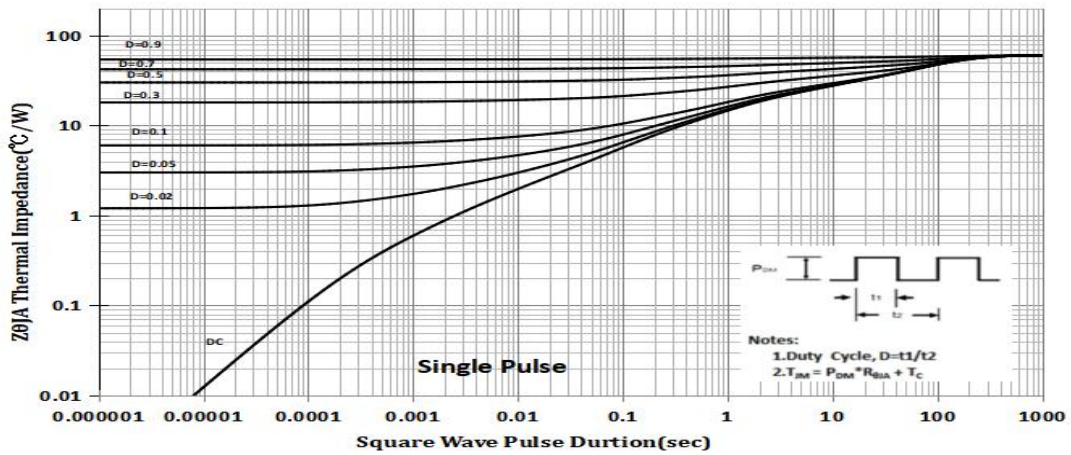


Fig 9 Normalized Maximum Transient Thermal Impedance

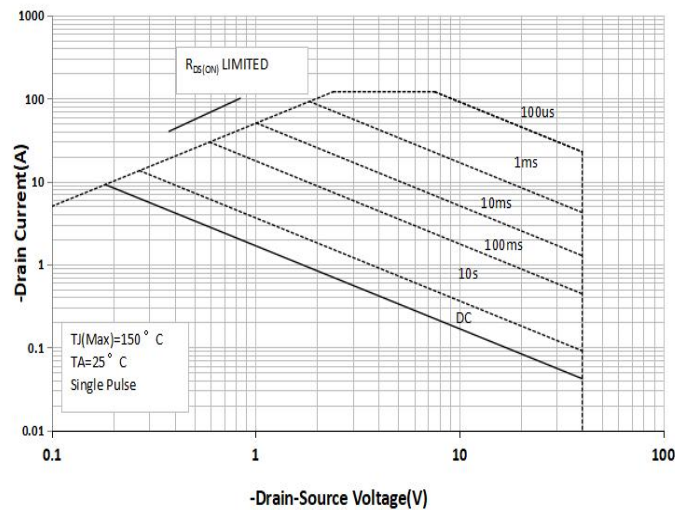
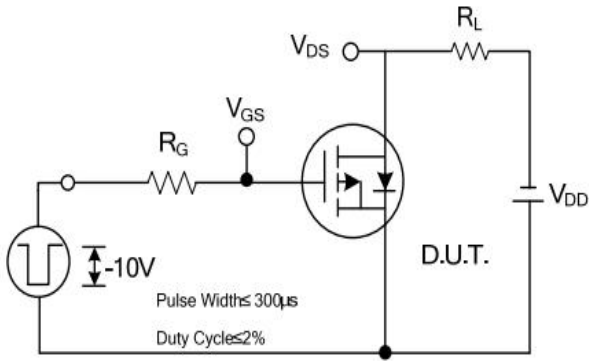
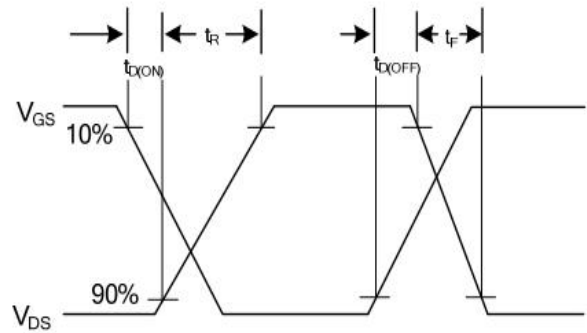


Fig 10 Safe Operation Area

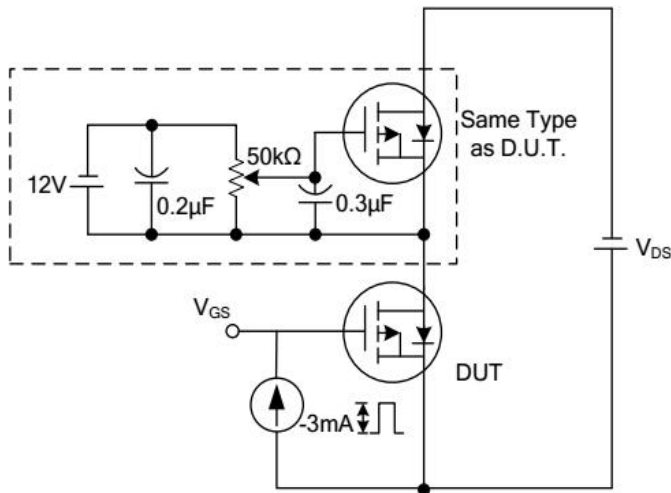
6 Typical Test Circuit and Waveform



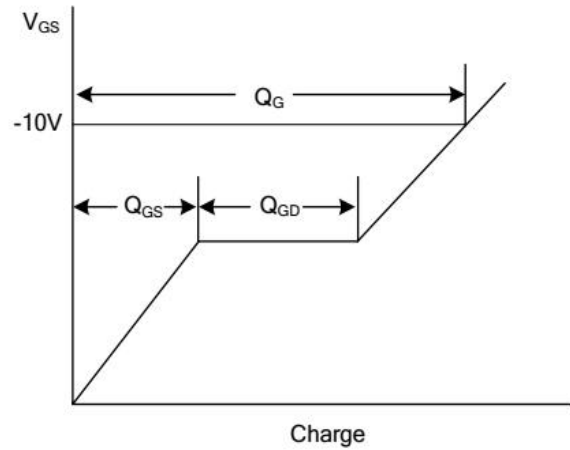
Switching Test Circuit



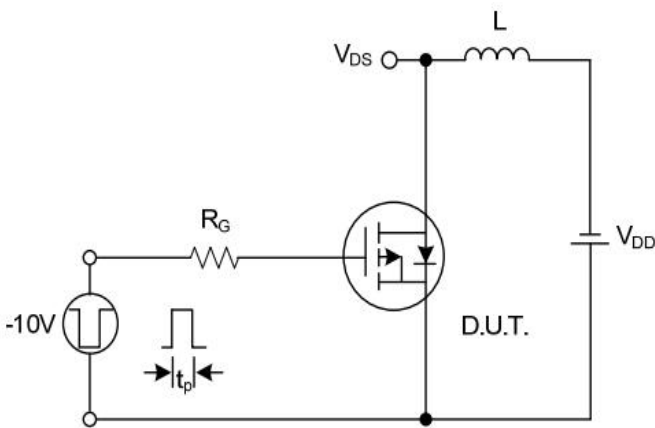
Switching Waveforms



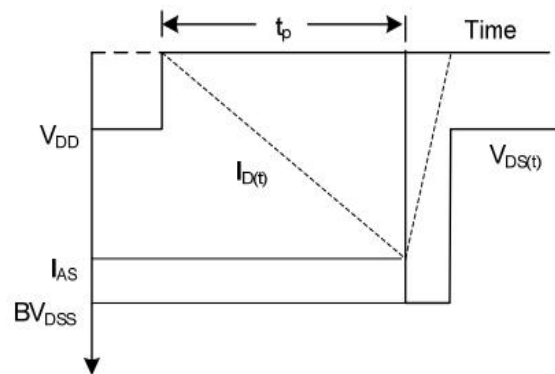
Gate Charge Test Circuit



Gate Charge Waveform

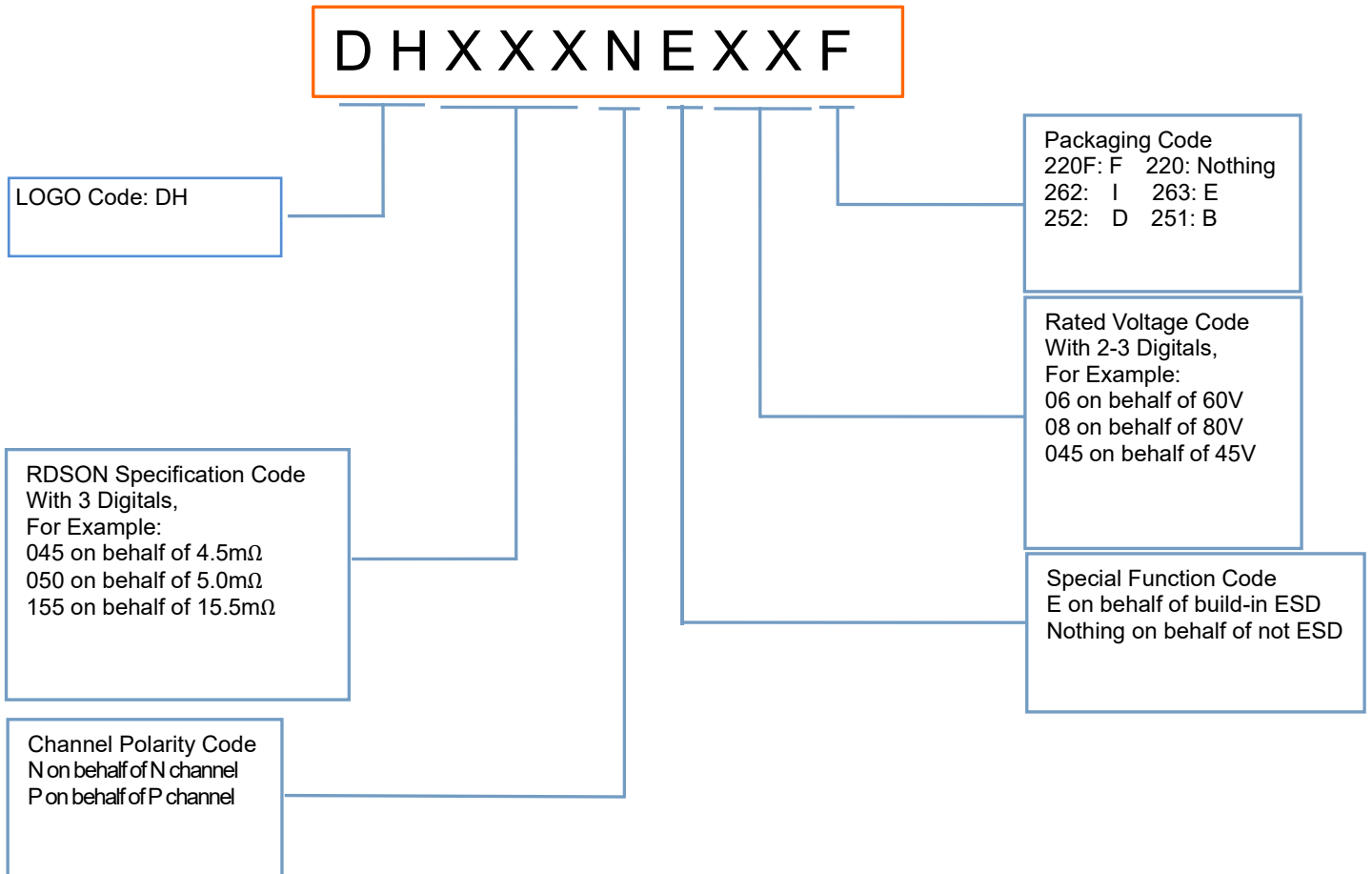


Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

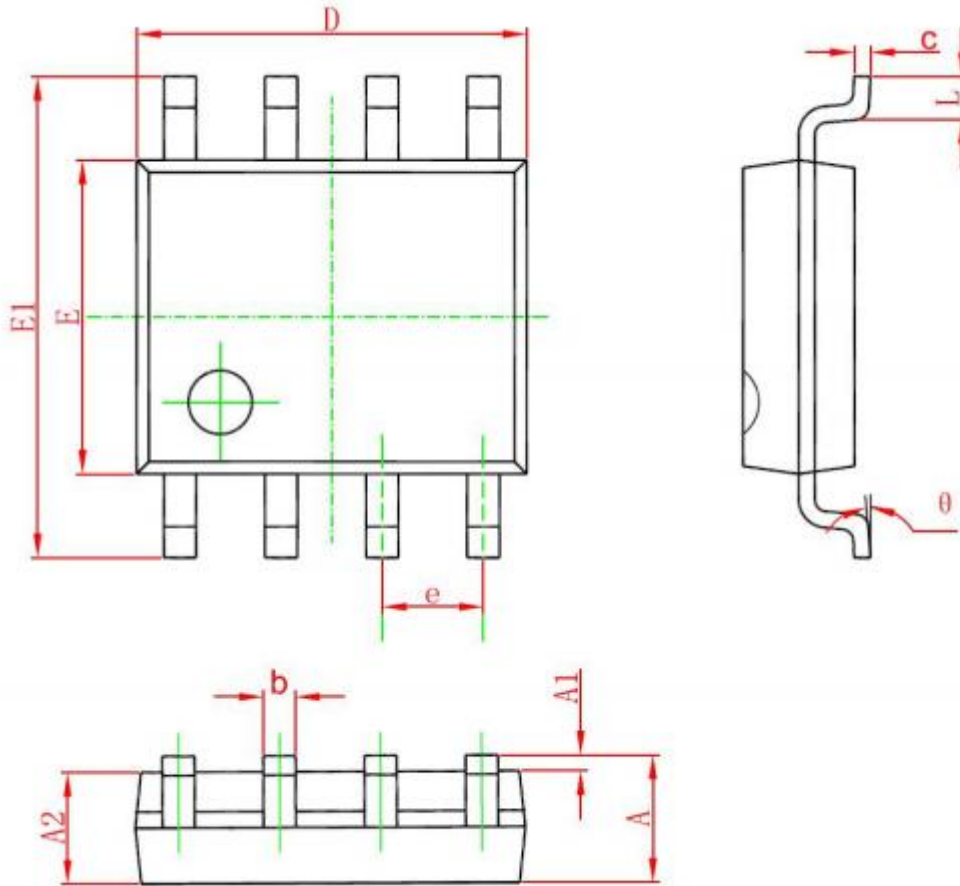
7 Product Names Rules



8 Product Specifications and Packaging Models

Product Model	Package Type	Mark Name	RoHS	Package	Quantity
DH170P04V	SOP-8	DH170P04V	Pb-free	Tube	2500/box

9 Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

10 Attentions

- Jiangsu Donghai Semiconductor Technology CO.,LTD. reserves the right to change the specification without prior notice! The customer should obtain the latest version of the information before making the order and verify that the information is complete and up to date.
- It is the responsibility of the purchaser for any failure or failure of any semiconductor product under certain conditions. It is the responsibility of the purchaser to comply with safety standards and to take safety measures in the system design and machine manufacturing of Donghai products in order to avoid potential risk of failure. Injury or property damage.
- Product promotion is endless, our company will be dedicated to provide customers with better products.

11 Appendix

Revision history:

Date	REV.	Description	Page
2022.08.09	1.0	Original	9